

Dex CE placement and process



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RC Dex: CE 1+2

CE marking lazer engraved on B cover



1. CE marking lazer engraved on B cover. Masked polished area for engraving.



2. CE marking lazer engraved on B cover. Engraving over VDI 27.



30 mm

52 mm

RC Dex: CE 3

3. CE marking lazer engraved and print on B cover



Size on RC Dex 1:1



• CE marking in mould

• Serial number pad printed on B cover

RC Dex: CE 4

3. CE marking lazer engraved and print on undersunk (0.3mm) area on B cover (area for possible label placement)

Edge marks undersunk area on B cover. Area has VDI 21.



RC Dex: CE 5

3. CE marking lazer engraved and print on undersunk (0.3mm) area on B cover (area for possible label placement)

